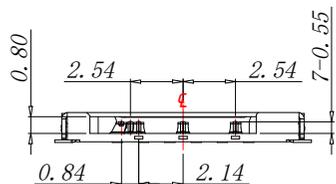
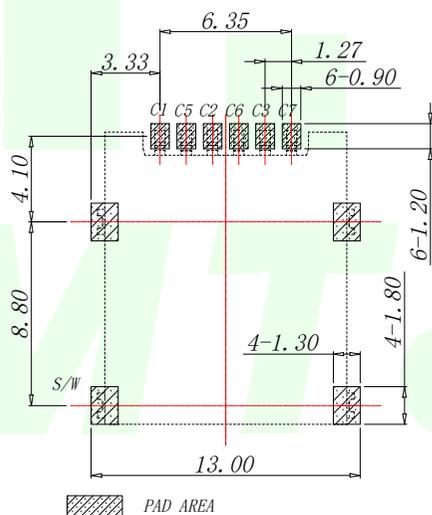


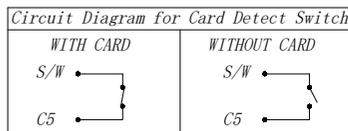
- NOTES:
- MATERIAL:
    - Housing: High Temperature Thermoplastic UL94V-0; Color Black.
    - Terminal: Copper Alloy, T=0.12mm.
    - Shell: Stainless Steel, T=0.20mm.
  - FINISH:
    - Terminal: Plated Gold on The Contact Area and Solder Tails
    - Peg: Plated Gold on the Solder Tails.
  - SPECIALITY:
    - Rated current: 0.5A
    - Rated voltage: 50V
    - Contact Resistance: 80mΩMAX
    - Insulation Resistance: 100MΩMIN 100V DC
    - Dielectric withstanding voltage: 100V AC.
    - Solder ability: 245±5° C, 5±0.5s.
    - Operating condition: Temperature: -40° C~+85° C Humidity: 80% R.H MAX



Pin No.	NAME
C1	VCC OF SIM
C2	RST OF SIM
C3	CLK OF SIM
C5	GND OF SIM
C6	VPP OF SIM
C7	I/O OF SIM
C4/C8	N/A
S/W	Switch Pin

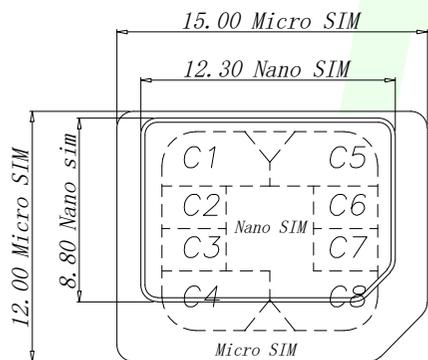


RECOMMENDED PCB LAYOUT  
GENERAL TOLERANCE ±0.05

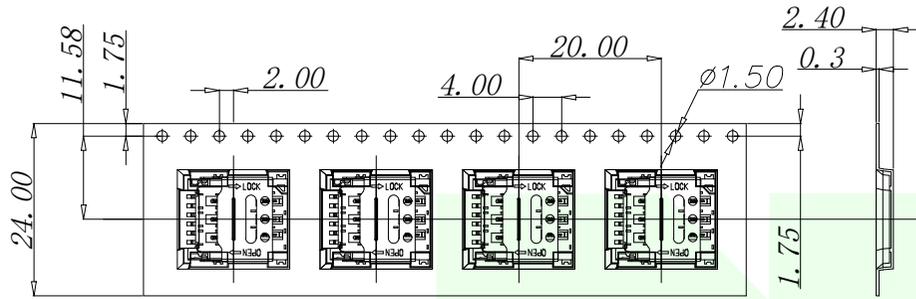


NO.	PART NAME	Q'TY	DESCRIPTION	NOTE
③	TERMINAL	6	C5210-EH, T=0.12	G/F PLATING
②	BASE INSULATOR	1	LCP+GF30%	BLACK
①	SHELL	1	SUS304-H, T=0.15	AU/Ni PLATING

GENERAL TOLERANCES UNLESS SPECIFIED		<b>深圳市华明通电子有限公司</b> Shenzhen Huamingtong Electronics Co., Ltd	
X.±0.50	X.°±2°	PART NO.	TITLE: 7pin 1.4h higne nano sim card conn
.X±0.20	.X.°±1°	NANO SIM 7P 1.4H	
.XX±0.10		DESIGN: James	CUSTOMER
MANUFACTURE DWG		CHED: Talen	SIZE: A4
		APPD: Sophia	UNITS: MM
			SCALE: N/A
			SHEET: 1/2



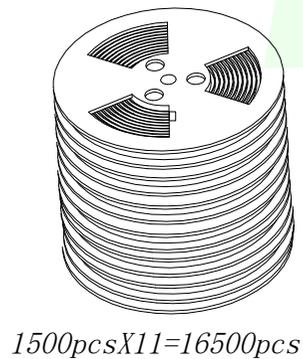
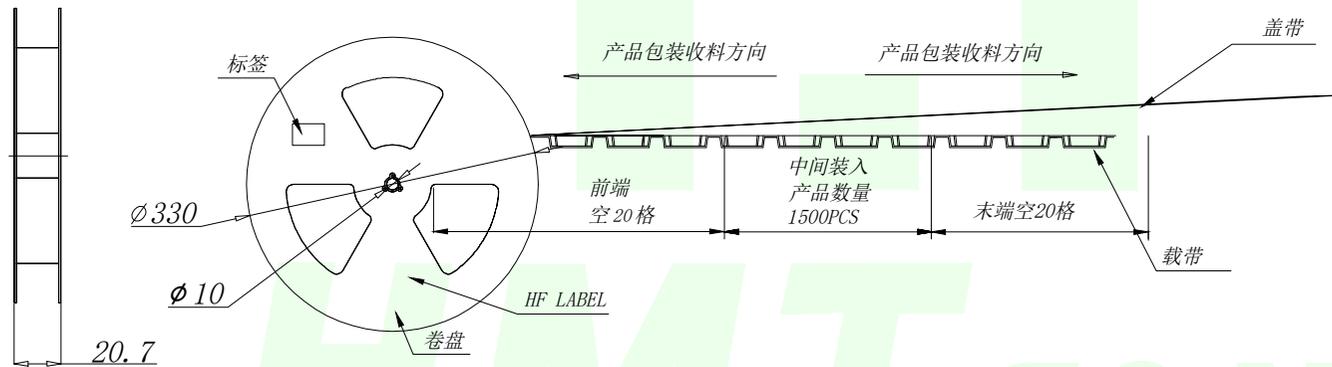
图示(一) 载带



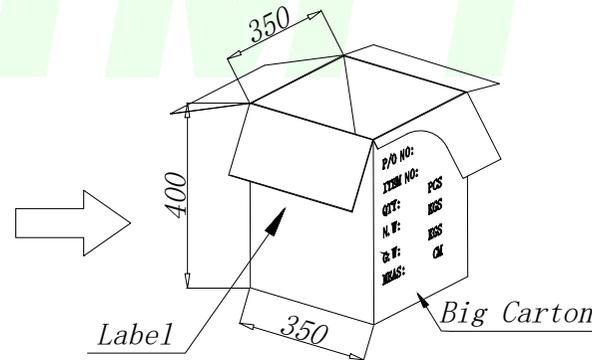
NOTES:

- 1, 每盘包装 1500PCS 产品. 包装要求如图示(二)
- 2, 每箱包装数量 16500PCS. 纸箱外则以胶带封口成(工)字型.
- 3, 上载带剥离不速度 :300mm/minutes.
- 4, 卷带封合力小于 100G.

图示(二) 圆盘包装



1500pcsX11=16500pcs



GENERAL TOLERANCES UNLESS SPECIFIED		 <b>深圳市华明通电子有限公司</b> Shenzhen Huamingtong Electronics Co., Ltd			
X.±0.50	X.°±2°	PART NO.	TITLE: 7pin 1.4h higne nano sim card conn		
.X±0.20	.X°±1°	NANO SIM 7P 1.4H			
.XX±0.10		DESIGN: James	CUSTOMER	SIZE	UNITS
MANUFACTURE DWG		CHED: Talen		A4	MM
		APPD: Sophia		SCALE	SHEET
				N:A	2/2